

# **DATA SHEET**

Product Name Metal Foil Chip Resistors

Part Name MS Series

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Brands

RoyalOhm UniOhm







#### 1. Scope

- 1.1 This specification for approve relates to the Metal Foil Chip Resistors manufactured by UNI-ROYAL.
- 1.2 High power rating.
- 1.3 Ultra low resistance value.
- 1.4 Excellent frequency response.
- 1.5 Excellent temperature coefficient characteristics.
- 1.6 RoHS compliant

#### 2. Part No. System

Part No. includes 14 codes shown as below:

2.1 1st~4th codes: Part name. E.g.: MS05, MS06, MS10, MS12

2.2 5th~6th codes: Power rating.

E.g.: W=Normal S	lize	"1~	G" = "1~1	6"	
Wattage	1/2	1	1.5	2	3
Normal Size	W2	1W	1A	2W	3W

2.3 7<sup>th</sup> code: Tolerance. E.g.:  $F=\pm1\%$  J= $\pm5\%$ 

2.4 8<sup>th</sup>~11<sup>th</sup> codes: Resistance Value.

2.4.1 If value belongs to standard value of  $\geq$  5% series, 8<sup>th</sup> code would be zero,9<sup>th</sup>~10<sup>th</sup> codes are significant figures of the resistance and 11<sup>th</sup> code is the power of ten.

2.4.2 If value belongs to standard value of  $\leq 2\%$  series,  $8^{th} \sim 10^{th}$  codes are significant figures of the resistance, and  $11^{th}$  code is the power of ten. 2.4.3  $11^{th}$  codes listed as following:

 $0=10^{0} 1=10^{1} 2=10^{2} 3=10^{3} 4=10^{4} 5=10^{5} 6=10^{6} J=10^{-1} K=10^{-2} L=10^{-3} M=10^{-4} N=10^{-5} P=10^{-6} 2.5 12^{th} \sim 14^{th} codes.$ 

2.5.1 12<sup>th</sup> code: Packaging Type. E.g.: T=Tape/Reel

2.5.2 13<sup>th</sup> code: Standard Packing Quantity.

4=4000pcs 5=5000pcs

2.5.3 14<sup>th</sup> code: Special features.

E = Black Marking. S=White Marking

#### 3. Ordering Procedure

(Example: MS12 3W ±1% 10mΩ T/R-4000)







#### 4. Marking

The first digit . Is "R" which as decimal point.



 $R010 \rightarrow 10m\Omega$ 

#### 5. Dimension



S=White Marking



<b>T</b>	70℃		Dime	ension(mm)			Resistance Range	T.C.R								
туре	Power	L	W	Н	Α	В	±1%&±5%	PPM/°C								
						0.65±0.15	$5 \text{ m}\Omega \sim 9\text{m}\Omega$									
1005	1/2W	2.00±0.30	1.20±0.30	0.60±0.20	≤1.0	0.57±0.15	12 mΩ~13mΩ	±150								
M805						0.42±0.15	15mΩ~30mΩ									
	1W	2.00±0.30	1.20±0.30	0.60±0.20	≤1.0	0.42±0.15	10mΩ	±50								
						0.86±0.25	$7\mathrm{m}\Omega$	±100								
						0.7(+0.25	$5m\Omega \sim 6m\Omega 8m\Omega 9m\Omega$	±100								
MS06	1W	3.10±0.20	1.60±0.30	0.70±0.20	≤1.0	0.76±0.25	$27m\Omega \sim 35m\Omega$	±50								
						0.46±0.25	$10 \text{m}\Omega \sim 25 \text{m}\Omega$	±100								
_							$37m\Omega \sim 51m\Omega$	±50								
			2.50±0.25	0.70±0.20		1.45±0.30	6mΩ	±50								
						1.25±0.30	$4m\Omega$ $7m\Omega$									
MS10	1.5W	V 5.00±0.20			0.70±0.20	0.70±0.20	0.70±0.20	0.70±0.20	0.70±0.20	0.70±0.20	0.70±0.20	≤1.0	≤1.0	1.00+0.20	$5m\Omega$ $8m\Omega$ $9m\Omega$ $10m\Omega$	±50
							1.00±0.50	11mΩ~25mΩ 150mΩ	±30							
_						0.65±0.30	30mΩ~100mΩ	±30								
				$1.00 \pm 0.20$	<1.0	2.55±0.30	1mΩ									
				1.00±0.20	_1.0	1.75±0.30	2mΩ	]								
						2.15±0.30	3mΩ	]								
MG12	3W	6.35±0.20	3.20±0.25			1.75±0.30	$4m\Omega$ $7m\Omega$ $8m\Omega$	150								
M512				$0.70 \pm 0.20$	≤1.0	1.35±0.30	5mΩ	±50								
						1.15±0.30	$6m\Omega$ $9m\Omega$ ~ $15m\Omega$	]								
						0.90±0.30	16mΩ~100mΩ	]								
	2W	6.35±0.20	3.20±0.25	0.70±0.20	≤1.0	0.90±0.30	101mΩ~200mΩ									





#### 6. <u>Structure</u>



1	Marking	4	Resistance layer
2	Alumina Substrate	5	Terminal (Cu/Ni/ Sn)
3	Protective layer		

#### 7. <u>Recommend land pattern</u>



#### 8. Derating Curve

Resistors shall have a power rating based on continuous load operation at an ambient temperature from -55  $^{\circ}$ C to 70  $^{\circ}$ C. For temperature in excess of 70  $^{\circ}$ C, the load shall be derated as shown in figure 1



#### 8.1 Voltage rating:

Resistors shall have a rated direct-current (DC) continuous working

Voltage or an approximate sine-wave root-mean-square (RMS) alternating-current (AC) continuous working voltage at commercial-line frequency and waveform corresponding to the power rating, as determined from the following formula:

$$RCWV = \sqrt{P \times R}$$

Where: RCWV commercial-line frequency and waveform (Volt.)

P = power rating (WATT.) R = nominal resistance (OHM)

In no case shall the rated DC or RMS AC continuous working voltage be greater than the applicable maximum value.

The overload voltage is 2.5 times RCWV or Max. Overload voltage whichever is less





#### 9. <u>Performance Specification</u>

Characteristic	Limits		Test Methods (GB/T5729&JIS-C-5201&IEC60115-1)		
Temperature Coefficient	Refer to it	em 5.0	4.8 Natural resistance changes per temp. Degree centigrade $\frac{R_2 \cdot R_1}{R_1(t_2 \cdot t_1)} \times 10^6 (PPM/^{\circ}C)$ R <sub>1</sub> : Resistance Value at room temperature (t <sub>1</sub> ); R <sub>2</sub> : Resistance at test temperature (Upper limit temperature or Lower limit temperature) t <sub>1</sub> : +25°C or specified room temperature t <sub>2</sub> : Upper limit temperature or Lower limit temperature test temperature		
Short-time overload	1% ±(1.0%+0.001Ω)		4.13 Permanent resistance change after the application of a potential of		
	5% ±(2.0%+0.001Ω)		times rated power for 5 seconds.		
Low Temperature Storage	±(1.0%+0.001Ω)		4.23.4 Lower limit temperature , for 1000H		
High Temperature Exposure	±(1.0%+0.001Ω)		4.23.2 Upper limit temperature , for 1000H		
Solderability	Solderability More than 95% coverage rate		4.17 The surface of solder must be new, smooth, clean, shiny and continuous, and without concentrated pinholes. The solder's temperature must be within 245±3 °C. Hold in hot solder 2~3seconds.		
soldering heat	±(0.5%+0	.005Ω)	4.18 Dipped into solder at 260°C for 10 seconds.		
Load life	1%	$\pm (1\%+0.001\Omega)$	4.25.1 Permanent resistance change after 1,000 hours operating at rated		
	5%	± (3%+0.001Ω)	power at 70±2°C, 1.5hrs ON ,0.5hrs OFF.		
T	1%	± (1.0%+0.001Ω)	7.0.4012°0 1000ha start has a 00.050/DH 1.5h ON 0.5h OFF		
Load life in numidity	5% ± (3.0%+0.001Ω)		7 7.9 40±2 €,1000hrs at rated power,90~95%RH , 1.5hrs ON,0.5hrs O		

## **10.** Packing of Surface Mount Resistors10.1 Dimension of Paper Taping :(Unit: mm)



Туре	A ±0.2	В ±0.2	C ±0.05	+0.1Φ D -0	Е ±0.1	F ±0.05	G ±0.1	W ±0.2	T ±0.1
MS05	1.65	2.40	2.00	1.50	1.75	3.50	4.00	8.00	0.81
MS06	2.00	3.60	2.00	1.50	1.75	3.50	4.00	8.00	0.81





### 10.2 Dimension of Embossed Taping: (Unit: mm)



Туре	A ± 0.2	В ± 0.2	С ± 0.05	+0.1 \$\overline{D}\$ -0	+0.25 \$\overline{D1}{-0}\$	Е ± 0.1	F ± 0.05	W ± 0.2	Т ±0.10	G ±0.1
MS10	2.90	5.60	2.00	1.50	1.50	1.75	5.50	12.00	1.00	4.00
MS12	3.50	6.70	2.00	1.50	1.50	1.75	5.50	12.00	1.00	4.00

#### 10.3 Dimension of Reel : (Unit: mm)



	TARRA			D : 0 5	<b>G</b> : 0 <b>F</b>				Wt.
Туре	TAPING	Qty/Reel	A±0.5	B±0.5	C±0.5	ΦD±1	ΦL±2	W±1	(mg)
MS05	Paper	5,000pcs	2.0	13.0	21.0	60.0	178.0	10.0	5.9
MS06	Paper	5,000pcs	2.0	13.0	21.0	60.0	178.0	10.0	13.6
MS10	Embossed	4,000pcs	2.0	13.0	21.0	60.0	178.0	13.8	35.0
MS12	Embossed	4,000pcs	2.0	13.0	21.0	60.0	178.0	13.8	50~104





#### 11. <u>Note</u>

11.1. UNI-ROYAL recommend the storage condition temperature: 15°C~35°C, humidity :25%~75%.

(Put condition for individual product). Even under UNI-ROYAL recommended storage condition, solderability of products over 1 year old. (Put condition for each product) may be degraded.

11.2. Store / transport cartons in the correct direction, which is indicated on a carton as a symbol.

Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.

11.3. Product performance and soldered connections may deteriorate if the products are stored in the following places:

- a. Storage in high Electrostatic.
- b. Storage in direct sunshine  $\$  rain and snow or condensation.
- c. Where the products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S<sub>3</sub> NH<sub>3</sub>, SO<sub>2</sub>, NO<sub>2</sub>.

#### 12. Record

Version	Description of amendment	Page	Date	Amended by	Checked by
1	First issue of this specification	1~7	Mar.20, 2018	Chen Haiyan	Chen Nana
2	<ol> <li>Add MS03 specifications</li> <li>Modify dimension resistance detail</li> </ol>	1~7 3~4	July.12, 2018	Chen Haiyan	Chen Nana
3	<ol> <li>Delete unrecommended specifications and blocks</li> <li>Add 1.6 items and modify 2.51, 2.52, 2.53, 3</li> <li>Add 5.0 item white code diagram</li> <li>Add 10.3 items of 1000-grain weight data</li> <li>Delete the 9.0 performance item Rapid change of temperature, Biased Humidity, Leaching</li> </ol>	1~7 2 3 3 6 5	Dec.4, 2018	Liao Dongmei	Wu shuai
4	Change the resistance range	3	Jan.24,2019	Wu shuai	Song qingfeng
5	Modify the product name	1~7	Feb.16, 2019	Chen Haiyan	Xu Yuhua

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